

4

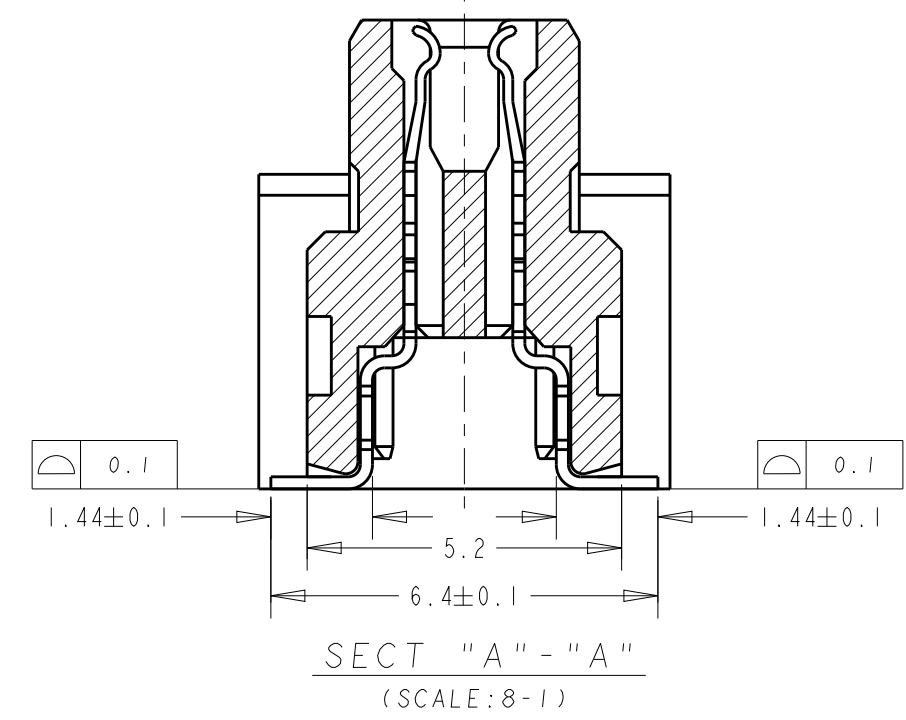
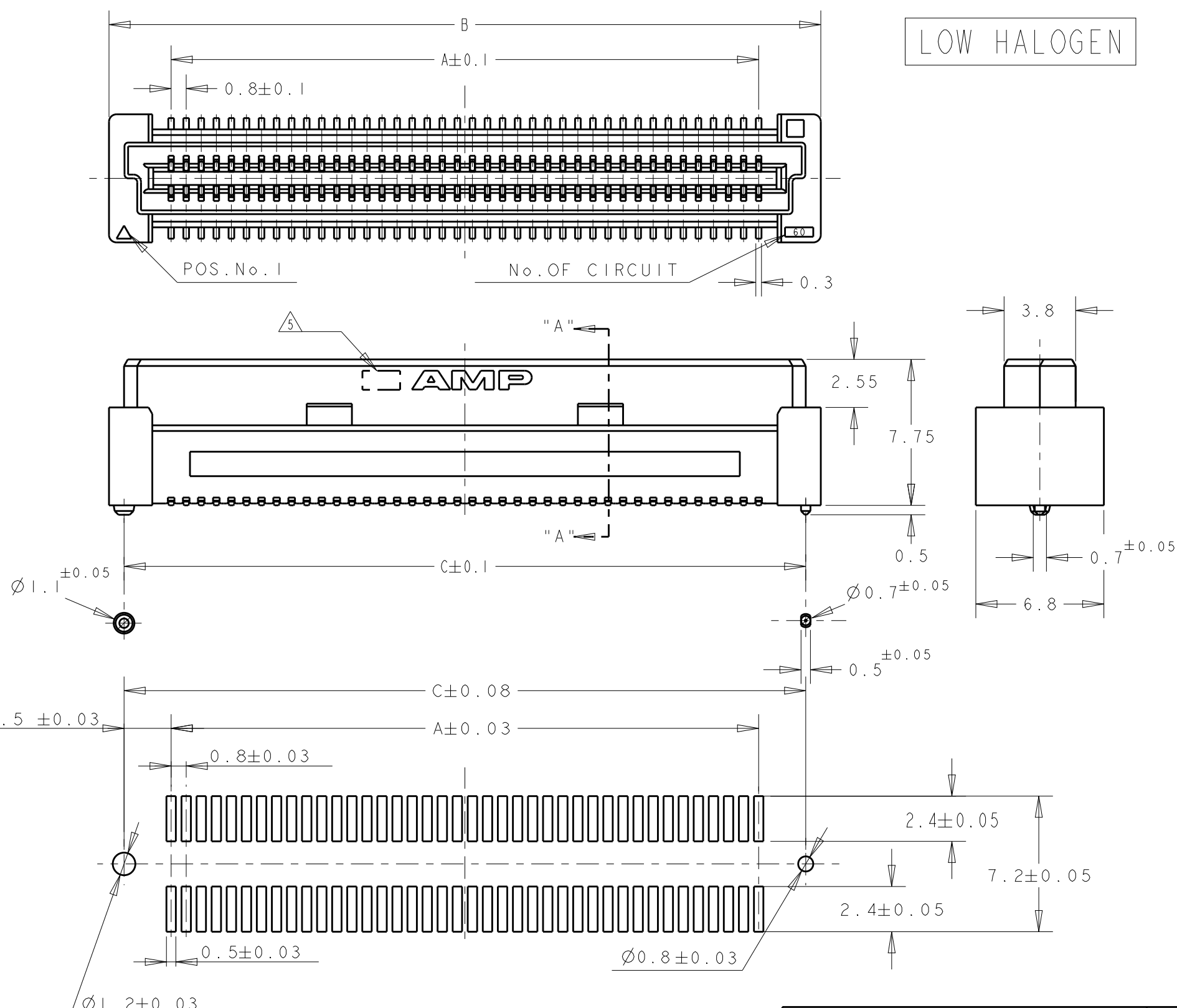
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2

1

REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	R	REVISED PER ECO-17-005566	27APR17	B.J	S.Y

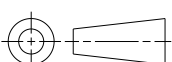
LOW HALOGEN



- NOTES;
- 1 MATERIAL: HOUSING: L.C.P. (HIGH TEMP. THERMOPLASTIC)
UL 94V-0, NATURAL.
CONTACT: BERYLIUM COPPER.
 - 2 FINISH: CONTACT AREA: 0.0002 MIN GOLD ON
0.0013 MIN ALL OVER NICKEL.
SOLDERING AREA: 0.002 MIN MATTE-TIN
 - 3. POSITION SERIES: SEE TABLE. (SHEET 2)
 - 4. CONN STACK HEIGHT COMBINE OF PLUG "Y" H VS REC "X" H.
STACK HEIGHT = Y + X - 5
 - 5 MANUFACTURE PLANT LOCATION MARK. QINGDAO:
 - 6 CONNECTOR WITH BLACK HOUSING AND POLYIMIDE COVER

RECOMMENDED P.C. BOARD LAYOUT

CONNECTOR ONLY

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 14SEP04 FLORENCE TAN		 TE Connectivity					
DIMENSIONS: mm		CHK ERIC TNG							
		APVD SE IFONG		NAME RCEPTACLE ASSEMBLY 9H TYPE FOR FH 0.8mm PITCH B-T-B CONNECTOR -					
		PRODUCT SPEC 108-5390							
		APPLICATION SPEC 114-5254		SIZE A3					
		WEIGHT -		CAGE CODE -					
MATERIAL 		FINISH 		DRAWING NO C-5179009		RESTRICTED TO -			
CUSTOMER DRAWING				SCALE 4:1		SHEET 1 OF 3			
				REV R					

P	LTR	DESCRIPTION	DATE	DWN	APVD
		SEE SHEET 1 OF 3			

SCALE	4:1	SHEET	2 OF 3	REV	R
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SEE SHEET 1 OF 3
$$\begin{array}{r} +1 \\ -2.5 \\ -508 \end{array}$$

SECT "A" - "A"

REC ASS'Y (H=9mm, W/STEEL COVER), 0.8mm BTB STACKING CONN

SECT "B" - "B"

SEE
DETAIL "A"

WITH POLYIMIDE COVER

DETAIL "A"
(SCALE 5-1)

LOW HALOGEN



TE Connectivity

DWN	14SEP04
FLORENCE TAN	
CHK	-
ERIC TNG	
APVD	-
SF LEONG	
PRODUCT SPEC	
108-5390	
APPLICATION SPEC	
114-5254	
WEIGHT	-
CUSTOMER DRAWING	

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[TE Connectivity:](#)

[5-5179009-9](#)